

Description

The AP5N40D is silicon N-channel Enhanced

VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency.



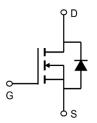
 $V_{DS} = 400V I_{D} = 5A$

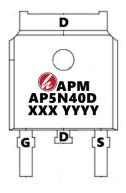
 $R_{DS(ON)} < 1.5\Omega$ @ $V_{GS}=10V$ (Type: 1.2Ω)

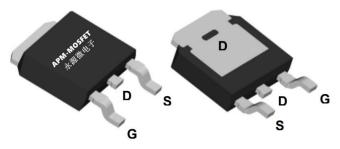


Uninterruptible Power Supply(UPS)

Power Factor Correction (PFC)







Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP5N40D	TO-252-3L	AP5N40D XXX YYYY	2500

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Symbol	Parameter	Value	Unit
VDSS	Drain-Source Voltage (V _{GS} = 0V)	400	V
ID	Continuous Drain Current	5	Α
IDM	Pulsed Drain Current	20	Α
VGSS	Gate-Source Voltage	±30	V
Eas	Single Pulse Avalanche Energy	90	mJ
IAS	Avalanche Current	3	Α
Ear	Repetitive Avalanche Energy	10	mJ
P _D	Power Dissipation (T _C = 25°C)	45	W
TJ, Tstg	Operating Junction and Storage Temperature Range	-55~+150	°C
RthJC	Thermal Resistance, Junction-to-Case	4.1	°C/W
RthJA	Thermal Resistance, Junction-to-Ambient	60	°C/W





Electrical Characteristics (T_J=25°C, unless otherwise noted)

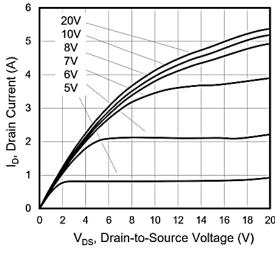
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250µA	400	440		V
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 500V, V _{GS} = 0V, T _J = 25°C			1	μA
IGSS	Gate-Source Leakage	V _{GS} = ±30V			±100	nA
VGS(th)	Gate-Source Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2.0	3.5	4.0	V
RDS(on)	Drain-Source On-Resistance (Note3)	V _{GS} = 10V, I _D = 2.5A		1.2	1.5	Ω
C _{iss}	Input Capacitance			462		
Coss	Output Capacitance	$V_{GS} = 0V,$ $V_{DS} = 25V, f = 1.0MHz$		54.2		pF
Crss	Reverse Transfer Capacitance	VDS - 20V, 1 - 1.0WHZ		8.8		
Qg	Total Gate Charge			13.5		
Q _{gs}	Gate-Source Charge	V _{DD} = 400V, I _D = 5A, V _{GS} = 10V		2		nC
Q _{gd}	Gate-Drain Charge]		6		
td(on)	Turn-on Delay Time			10		
tr	Turn-on Rise Time] 		25		
td(off)	Turn-off Delay Time	$V_{DD} = 250V$, $I_D = 5A$, $R_G = 25 \Omega$		40		ns
t _f	Turn-off Fall Time]		52		
ls	Continuous Body Diode Current	T 05.00			5	
ISM	Pulsed Diode Forward Current	T _C = 25 °C			20	A
V _{SD}	Body Diode Voltage	T _J = 25°C, I _{SD} = 5.0A, V _{GS} = 0V			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V,I _S = 5.0A, di _F /dt =100A		220		ns
Q _{rr}	Reverse Recovery Charge	/µs		3		μC

Note:

- 1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
- 2. The EAS data shows Max. rating . IAS = 2.5A, VDD = 50V, RG = 25 Ω , Starting TJ = 25 $^{\circ}$ C
- 3、The test condition is Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%
- 4、The power dissipation is limited by 150 $^{\circ}\mathrm{C}$ junction temperature
- 5、The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.



Typical Characteristics



 $T_{\rm J} = 150^{\circ}{\rm C}$ $T_{\rm J} = 25^{\circ}{\rm C}$ 10° 10° 0.2 0.4 0.6 0.8 1 1.2 1.4 0.8 0

Is, Source Current (A)

Figure 1. Output Characteristics (T J = 25°C)

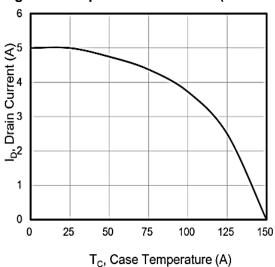


Figure 2. Body Diode Forward Voltage

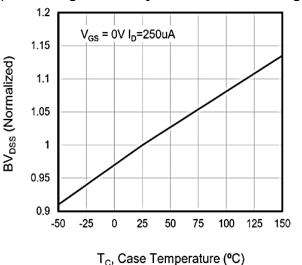


Figure 3. Drain Current vs. Temperature

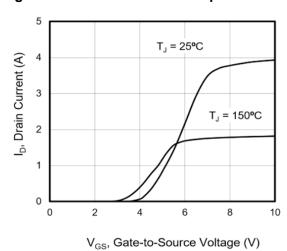


Figure 4. BV DSS Variation vs. Temperature

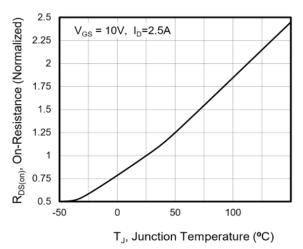
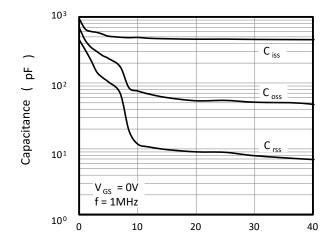


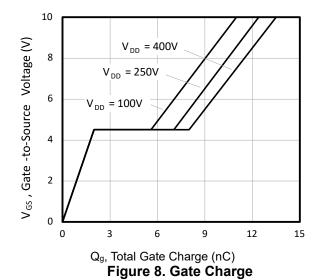
Figure 5. Transfer Characteristics

Figure 6. On-Resistance vs. Temperature









V_{DS}, Drain-to-Source Voltage (V) **Figure 7. Capacitance**

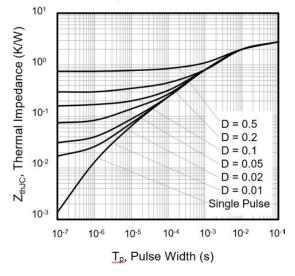
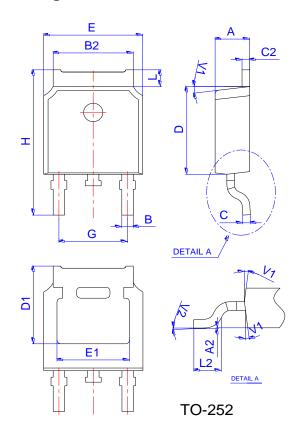


Figure 9. Transient Thermal Impedance

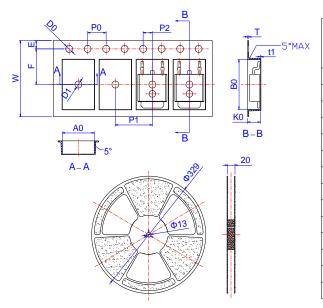


Package Mechanical Data: TO-252-3L



	Dimensions					
Ref.	Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
В	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
С	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF		0.209REF			
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
Н	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Spectification-TO-252



	Dimensions				Dime			
Ref.	Millimeters			Inches				
	Min.	Тур.	Max.	Min.	Тур.	Max.		
W	15.90	16.00	16.10	0.626	0.630	0.634		
Е	1.65	1.75	1.85	0.065	0.069	0.073		
F	7.40	7.50	7.60	0.291	0.295	0.299		
D0	1.40	1.50	1.60	0.055	0.059	0.063		
D1	1.40	1.50	1.60	0.055	0.059	0.063		
P0	3.90	4.00	4.10	0.154	0.157	0.161		
P1	7.90	8.00	8.10	0.311	0.315	0.319		
P2	1.90	2.00	2.10	0.075	0.079	0.083		
A0	6.85	6.90	7.00	0.270	0.271	0.276		
В0	10.45	10.50	10.60	0.411	0.413	0.417		
K0	2.68	2.78	2.88	0.105	0.109	0.113		
Т	0.24		0.27	0.009		0.011		
t1	0.10			0.004				
10P0	39.80	40.00	40.20	1.567	1.575	1.583		



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Edition	Date	Change
Rve1.0	2021/1/31	Initial release

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